

AMENDMENTS TO THE SPECIFICATION

Please replace the paragraph beginning at page 57, line 1, with the following rewritten paragraph:

-- As shown in FIG. 313 (a), the resin sheet 18 and a metal sheet 44 which has a larger thickness than the resin sheet 18 and is superposed on the conductive layer 26 of the resin sheet 18 are so fed to a die that the resin sheet is on the side of the lower part 16. --

Please replace the paragraph beginning at page 65, line 21, with the following rewritten paragraph:

-- For example, there are optimum ranges of the thickness (t1) of the conductor and the thickness (t2) of the substrate. Those thicknesses are determined so as to satisfy a relation of preferably $1.4 \times t_2 \leq t_1 \leq 0.7 \times t_2$ $1.4 \times t_2 \geq t_1 \geq 0.7 \times t_2$, more preferably $1.3 \times t_2 \leq t_1 \leq 0.8 \times t_2$ $1.3 \times t_2 \geq t_1 \geq 0.8 \times t_2$, still more preferably $1.2 \times t_2 \leq t_1 \leq 0.9 \times t_2$ $1.2 \times t_2 \geq t_1 \geq 0.9 \times t_2$. When the thicknesses are determined as above, unevenness of the substrate surface hardly occurs, and electrical connection between the front and back surfaces of the insulating substrate is easily attained. --